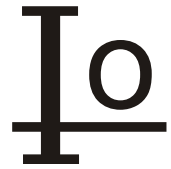


ABS2 THRU ABS10



Single Phase 1.0 AMP. Glass Passivated Bridge Rectifiers

Thin Mini-Dip



Features

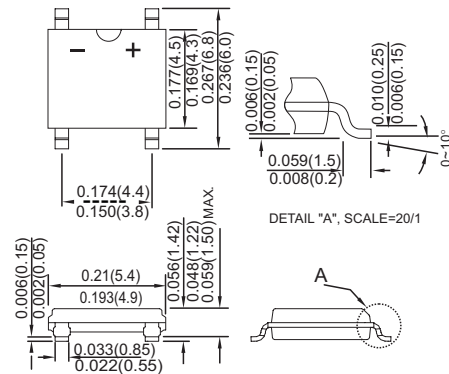
- ✧ Glass passivated junction
- ✧ Ideal for printed circuit board
- ✧ Reliable low cost construction utilizing molded plastic technique
- ✧ High temperature soldering guaranteed: 260°C / 10 seconds / 0.375" (9.5mm) lead length at 5 lbs., (2.3 kg) tension
- ✧ Small size, simple installation
Leads solderable per MIL-STD-202, Method 208
- ✧ High surge current capability
- ✧ Lead Free Finish/RoHS Compliant

VOLTAGE RANGE

50 to 1000 Volts

CURRENT

1.0 Ampere



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbo	ABS2	ABS4	ABS6	ABS8	ABS10	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	140	280	420	560	700	V
Maximum DC Blocking Voltag	V_{DC}	200	400	600	800	1000	V
Maximum Average Forward Rectified Current On glass-epoxy On aluminum substrate	$I_{F(AV)}$			0.8 1.0			A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}			30			A
Maximum Instantaneous Forward Voltage (Note 1) @ 0.5A	V_F			0.95			V
Rating for fusing ($t < 8.3ms$)	I^2T			3.74			A ² sec
Maximum DC Reverse Current at Rated DC Blocking Voltage	I_R			10 150			uA
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$ $R_{\theta JA}$			25 80			°C/W
Operating Temperature Range	T_J			- 55 to + 150			°C
Storage Temperature Range	T_{STG}			- 55 to + 150			°C

Note 1: Pulse Test with PW=300 usec, 1% Duty Cycle

Note 2: Mounted on P.C.B. with 5mm x 5mm Copper Pads

RATINGS AND CHARACTERISTIC CURVES (ABS2 THRU ABS10)

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

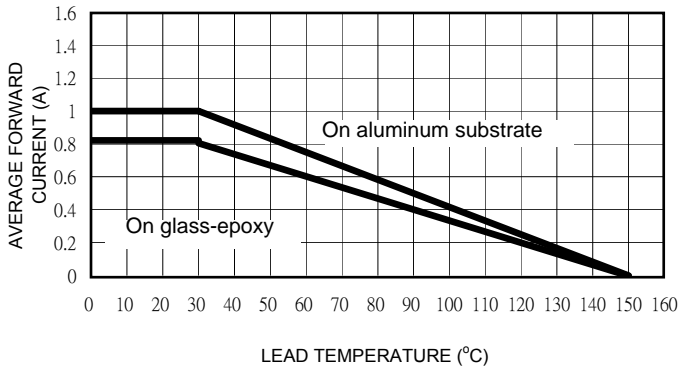


FIG. 2 TYPICAL REVERSE CHARACTERISTICS

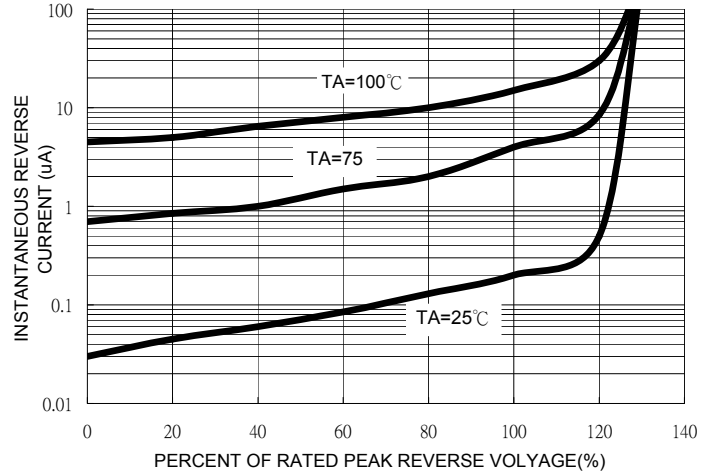


FIG. 3 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

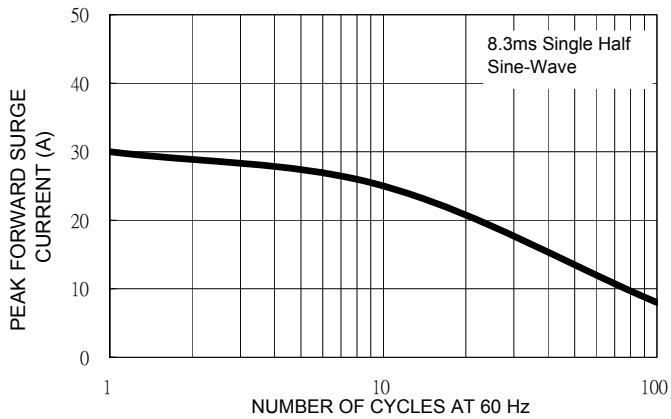


FIG. 4 TYPICAL JUNCTION CAPACITANCE

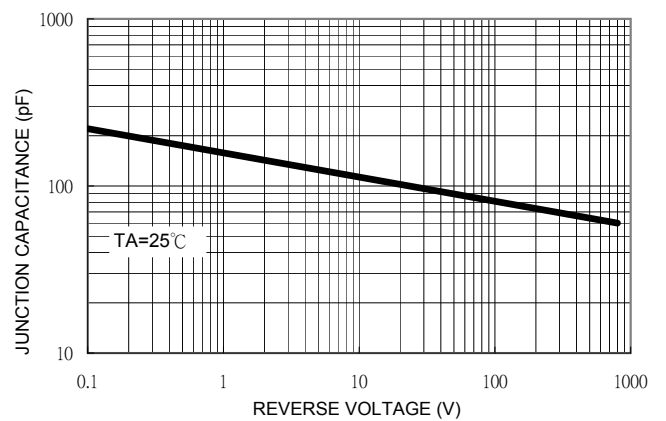


FIG. 5 TYPICAL FORWARD CHARACTERISTICS

